

SGSP317-VB Datasheet N-Channel 200 V (D-S) MOSFET

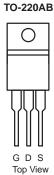
PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	
200	0.270 at V _{GS} = 10 V	10	

FEATURES

- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



G C S N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted) Symbol Limit Unit Parameter **Drain-Source Voltage** V_{DS} 200 V Gate-Source Voltage V_{GS} ± 20 T_C = 25 °C 10 Continuous Drain Current (T_J = 175 °C)^b I_D T_C = 125 °C 6 **Pulsed Drain Current** I_{DM} А 38 Continuous Source Current (Diode Conduction) I_S 12 Avalanche Current I_{AS} 10 Single Pulse Avalanche Energy L = 0.1 mH E_{AS} 18 mJ T_C = 25 °C 121^b Maximum Power Dissipation P_D W T_A = 25 °C 2^a Operating Junction and Storage Temperature Range °C T_J, T_{stg} - 55 to 175

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
hur stien te Anshiend	$t \le 10 \text{ s}$	R _{thJA}	15	18	
Junction-to-Ambient ^a	Steady State	I thJA	40	50	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

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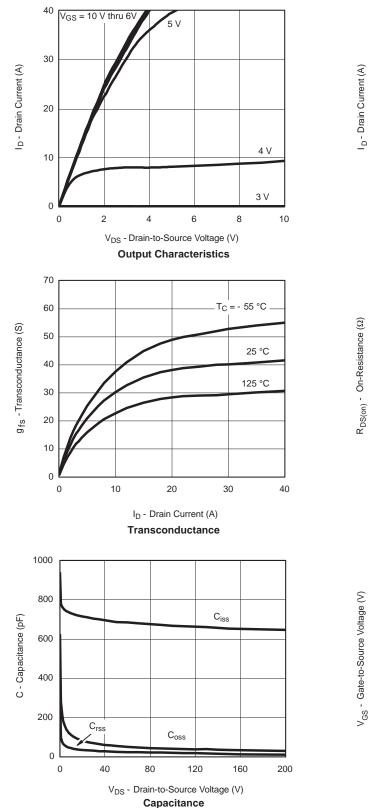
SPECIFICATIONS ($T_J = 25$ °	C, unless d	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	40			А	
		V _{GS} = 10 V, I _D = 5 A		0.270			
	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C		0.320		0	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C		0.410		Ω	
		V_{GS} = 4.5 V, I _D = 5 A		0.310			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 19 A		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			800			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		110		pF	
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge ^c	Qg			30			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 19 A		8		nC	
Gate-Drain Charge ^c	Q _{gd}			12			
Gate Resistance	Rg		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 5.2 Ω		50	75		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 19 A, V_GEN = 10 V, R_g = 2.5 Ω		30	45	ns	
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Char	acteristics (_C = 25 °C)			I		
Pulsed Current	I _{SM}				40	A	
Diode Forward Voltage ^b	V _{SD}	I _F = 19 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		180	250	ns	

Notes:

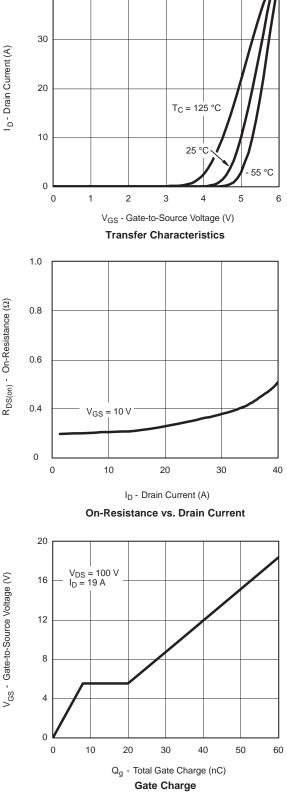
a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





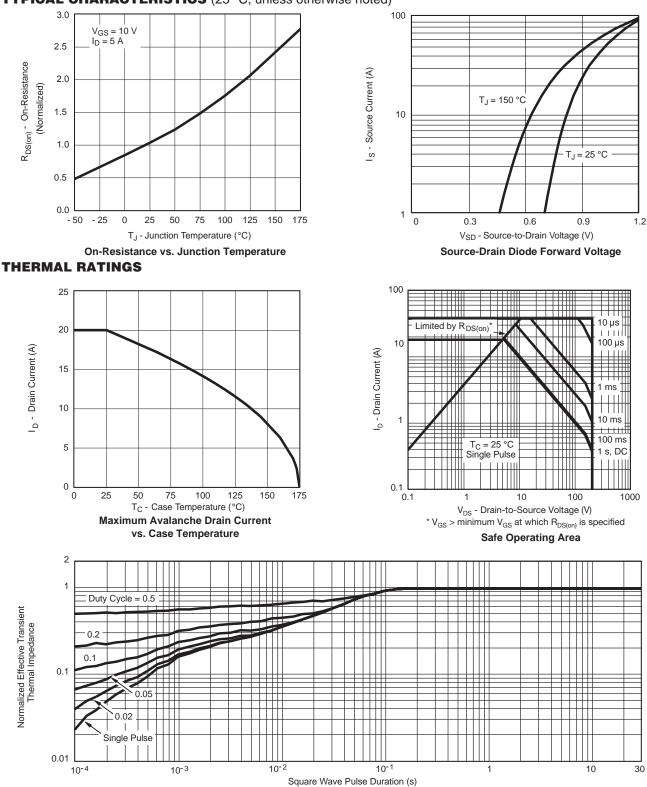
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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服务热线:400-655-8788



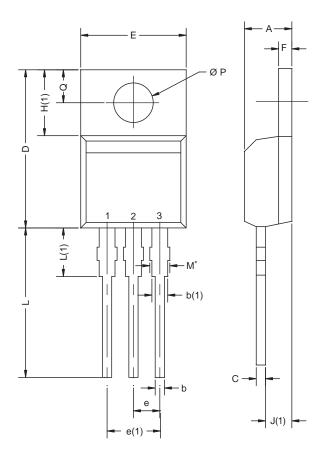


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



MIN. 4.25 0.69 1.20 0.36 14.85 10.04 2.41	MAX. 4.65 1.01 1.73 0.61 15.49 10.51	MIN. 0.167 0.027 0.047 0.014 0.585 0.395	MAX. 0.183 0.040 0.068 0.024 0.610 0.414
0.69 1.20 0.36 14.85 10.04	1.01 1.73 0.61 15.49 10.51	0.027 0.047 0.014 0.585	0.040 0.068 0.024 0.610
1.20 0.36 14.85 10.04	1.73 0.61 15.49 10.51	0.047 0.014 0.585	0.068 0.024 0.610
0.36 14.85 10.04	0.61 15.49 10.51	0.014 0.585	0.024 0.610
14.85 10.04	15.49 10.51	0.585	0.610
10.04	10.51		
		0.395	0.414
2.41			0.414
	2.67	0.095	0.105
4.88	5.28	0.192	0.208
1.14	1.40	0.045	0.055
6.09	6.48	0.240	0.255
2.41	2.92	0.095	0.115
13.35	14.02	0.526	0.552
3.32	3.82	0.131	0.150
3.54	3.94	0.139	0.155
2.60	3.00	0.102	0.118
	1.14 6.09 2.41 13.35 3.32 3.54 2.60	1.14 1.40 6.09 6.48 2.41 2.92 13.35 14.02 3.32 3.82 3.54 3.94	1.141.400.0456.096.480.2402.412.920.09513.3514.020.5263.323.820.1313.543.940.1392.603.000.102

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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